



STP3052D



P Channel Enhancement Mode MOSFET

-25.0A

DESCRIPTION

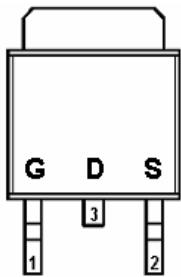
STP3052D is the P-Channel logic enhancement mode power field effect transistor which is produced using high cell density, DMOS trench technology.

This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application. Such as DC/DC converter and Desktop computer power management.

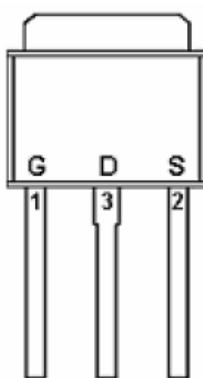
The package is universally preferred for commercial industrial surface mount applications.

PIN CONFIGURATION (D-PAK)

TO-252



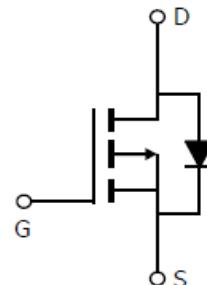
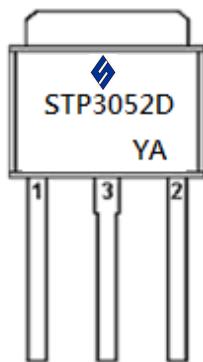
TO-251



FEATURE

- -30V/-25.0A, $R_{DS(ON)} = 45m\Omega$ (Typ.) @ $V_{GS} = -10V$
- -30V/-16.0A, $R_{DS(ON)} = 78m\Omega$ @ $V_{GS} = -5.0V$
- Super high density cell design for extremely low $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability
- TO-252,TO-251 package design

PART MARKING



Y: Year Code A: Process Code

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ABSOLUTE MAXIMUM RATINGS (Ta = 25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit	
Drain-Source Voltage	VDSS	-30	V	
Gate-Source Voltage	VGSS	±20	V	
Continuous Drain Current (TJ=150°C)	TA=25°C TA=70°C	ID	-25.0 -18.0	A
Pulsed Drain Current	IDM	-100	A	
Continuous Source Current (Diode Conduction)	IS	-15	A	
Power Dissipation	TA=25°C TA=70°C	PD	40 20	W
Operation Junction Temperature	TJ	150	°C	
Storage Temperature Range	TSTG	-55/150	°C	
Thermal Resistance-Junction to Ambient	RθJA	105	°C/W	



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ELECTRICAL CHARACTERISTICS (Ta = 25°C Unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit	
Static							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, ID=-250uA	-30			V	
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , ID=-250uA	-1.0		-3.0	V	
Gate Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V			±100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-40V, V _{GS} =0V			-1	uA	
		V _{DS} =-40V, V _{GS} =0V T _J =55°C			-5		
Drain-source On-Resistance	R _{Ds(on)}	V _{GS} =-10V, I _D =-25A V _{GS} =-5.0V, I _D =-16A		45 78	50 85	mΩ	
Forward Transconductance	g _{fs}	V _{DS} =-10V, I _D =-8A		8		S	
Diode Forward Voltage	V _{SD}	I _s =-16A, V _{GS} =0V			-1.2	V	
Dynamic							
Total Gate Charge	Q _g	V _{DS} =-15V, V _{GS} =-100V I _D =-3.5A		16.5		nC	
Gate-Source Charge	Q _{gs}			2.8			
Gate-Drain Charge	Q _{gd}			4.5			
Input Capacitance	C _{iss}	V _{DS} = -15V, V _{GS} =0V F=1MHz		700		pF	
Output Capacitance	C _{oss}			129			
Reverse TransferCapacitance	C _{rss}			75			
Turn-On Time	t _{d(on)} tr	V _{DD} =-15V, R _L =15Ω R _{GEN} =-10V, R _G =6Ω I _D ≡-1.0A			25	nS	
					26		
Turn-Off Time	t _{d(off)} tf				70		
					50		

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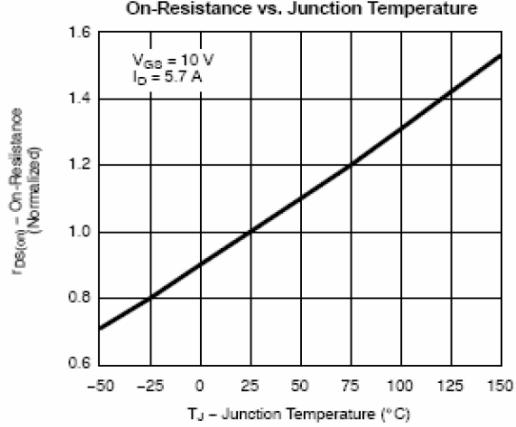
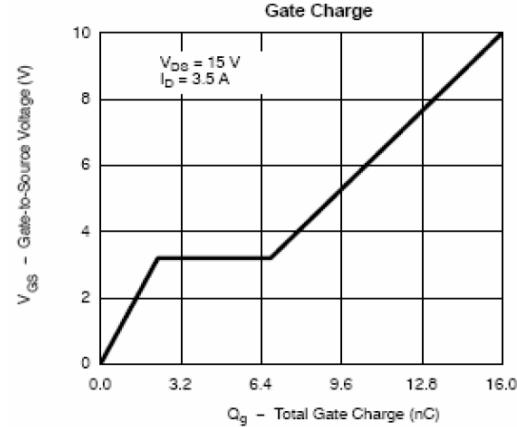
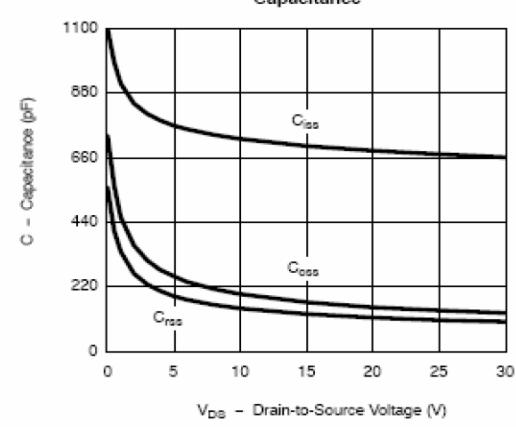
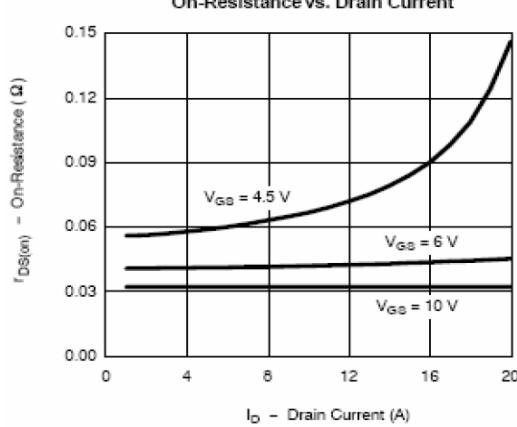
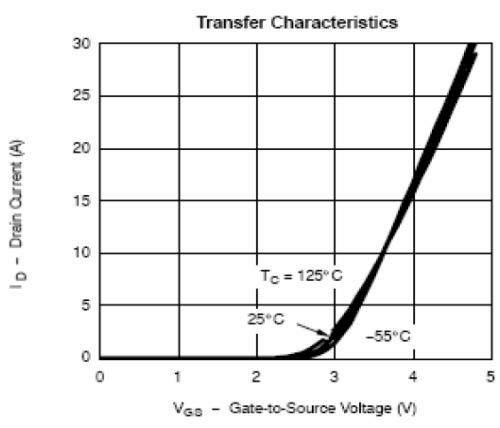
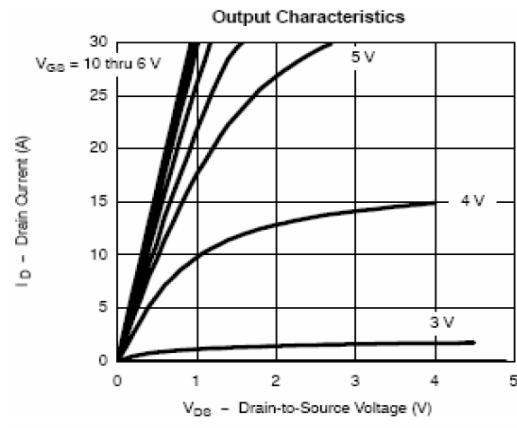
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TYPICAL CHARACTERISTICS



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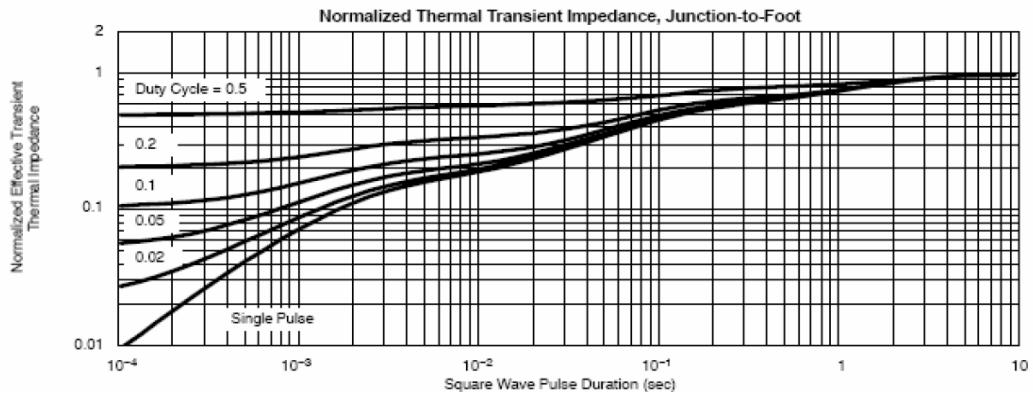
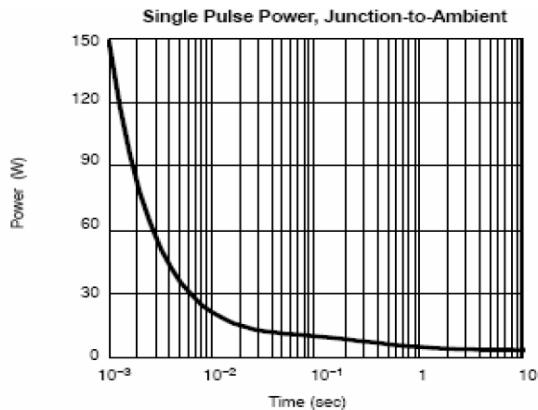
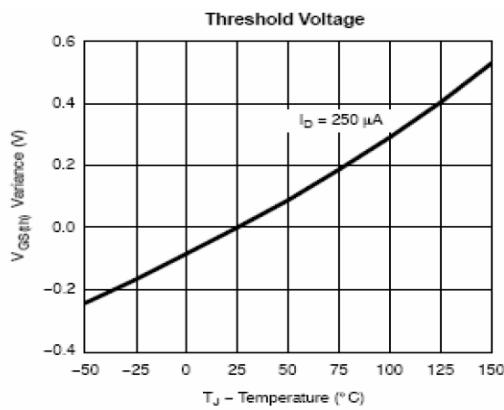
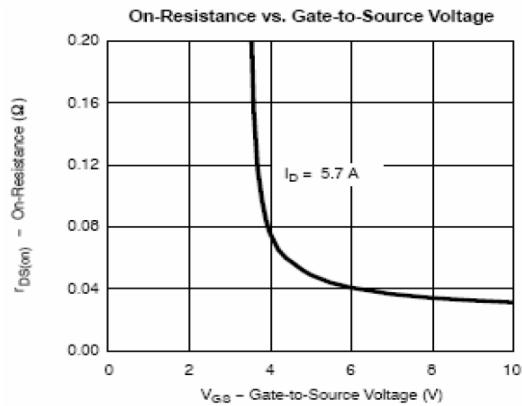
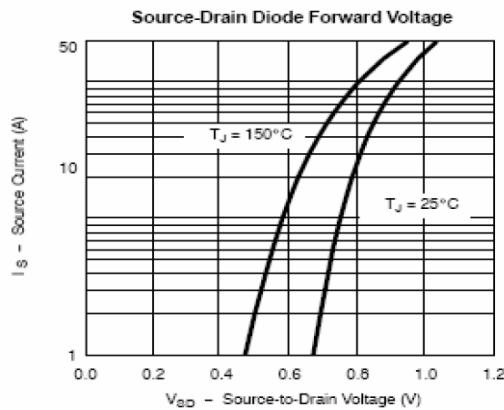
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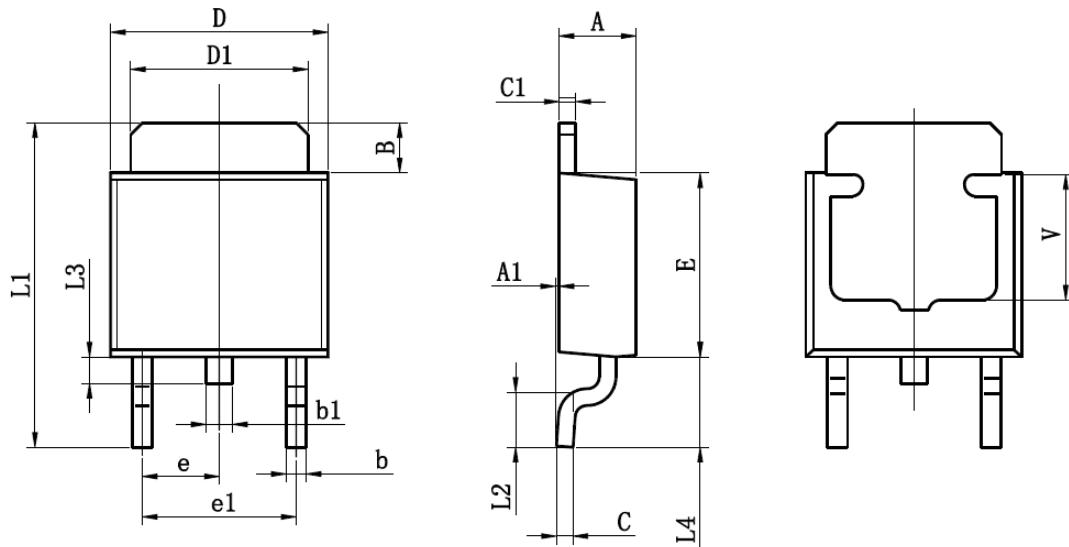
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TO-252-2L PACKAGE OUTLINE



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
B	1.350	1.650	0.053	0.065
b	0.500	0.700	0.020	0.028
b1	0.700	0.900	0.028	0.035
c	0.430	0.580	0.017	0.023
c1	0.430	0.580	0.017	0.023
D	6.350	6.650	0.250	0.262
D1	5.200	5.400	0.205	0.213
E	5.400	5.700	0.213	0.224
e	2.300TYP		0.091TYP	
e1	4.500	4.700	0.177	0.185
L1	9.500	9.900	0.374	0.390
L2	1.400	1.780	0.055	0.070
L3	0.650	0.950	0.026	0.037
L4	2.550	2.900	0.100	0.114
V	3.80REF		0.150REF	

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